

# **SMF3.3**





#### **Agency Approvals**

AGENCY	AGENCY FILE NUMBER
<b>71</b> °	E230531

# Maximum Ratings and Thermal Characteristics (T<sub>a</sub>=25°C unless otherwise noted)

Parameter		Symbol	Value	Unit
Peak Pulse Power	8/20µs	D	1200	W
Dissipation at T <sub>A</sub> =25°C (Note 1)	10/1000µs	P <sub>PPM</sub>	200	W
Thermal Resistance Ambient	$R_{_{\theta JA}}$	220	°C/W	
Thermal Resistanc	$R_{\theta JL}$	100	°C/W	
Operating Tempera	T <sub>J</sub>	-55 to 150	°C	
Storage Temperatu	ire Range	$T_{STG}$	-55 to 150	°C

#### Notes:

1. Non-repetitive current pulse, per Fig. 4 & 6 and derated above  $T_{_{\rm J}}$  (initial) =25°C per Fig. 3.

#### Description

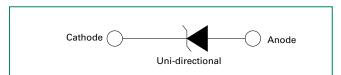
SMF3.3 is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

#### **Features**

- 200W peak pulse power capability at 10/1000µs waveform, repetition rate (duty cycle): 0.01%
- 1200W peak pulse power capability at 8/20us waveform
- Excellent clamping capability
- Compatible with industrial standard package SOD-123FL
- Low profile: maximum height of 1.08mm.
- For surface mounted applications to optimize board space
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 30kV(Air), 30kV (Contact)

- ESD protection of data lines in accordance with IEC 61000-4-2
- EFT protection of data lines in accordance with IEC 61000-4-4
- Fast response time: typically less than 1.0ns from 0 Volts to V<sub>BB</sub> min
- High temperature soldering: 260°C/40 seconds at terminals
- Built-in strain relief
- Meet MSL level1, per J-STD-020C, LF maximun peak of 260°C
- Matte tin lead-free plated
- Halogen-free and RoHS compliant
- Pb-free E3 means 2<sup>nd</sup> level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/ JEDEC J-STD-609A.01)

## **Functional Diagram**



### **Applications**

SMF3.3 devices are ideal for the protection of portable devices/hard drives, notebooks,  $V_{\rm CC}$  busses, POS terminal, SSDs, power supplies, monitors, and vulnerable circuit used in other consumer applications.

#### Electrical Characteristics (T<sub>a</sub>=25°C unless otherwise noted)

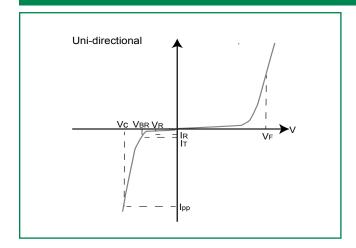
Part Number	Marking Code	Voltaç	akdown Test current	Reverse Stand off Voltage V <sub>R</sub>	Maximum Reverse Leakage @ V。	Maximum Peak Pulse Current	Maximum Clamping Voltage @l <sub>oo</sub>	Maximum Peak Pulse Current	Maximum Clamping Voltage @l <sub>oo</sub>		
		MIN	MAX	(mA)	(V)		(10/1000µS) I <sub>pp</sub> (A)	(10/1000µS) V <sub>c</sub> (V)	(8/20µS) I <sub>pp</sub> (A)	(8/20µS)	
SI	VVE3 3	33	3.4	13	10	3.3	0.5	30.0	6.8	120.0	10.0

#### Notes:

- 1.  $V_{gR}$  measured after  $I_{T}$  applied for 300µs,  $I_{T}$  = sequare wave pulse or equivalent.
- 2. Surge current waveform per 10/1000µs exponential wave and derated per Fig.2.
- 3. All terms and symbols are consistent with ANSI/IEEE C62.35.
- 4. Surge current waveform per 8/20µs exponential wave and derated per Fig.6.



#### **I-V Curve Characteristics**



- $\mathbf{P}_{\scriptscriptstyle{\mathbf{PPM}}}$  Peak Pulse Power Dissipation Max power dissipation
- $V_{BR}$  **Breakdown Voltage** -- Maximum voltage that flows though the TVS at a specified test current ( $I_{\gamma}$ )
- V<sub>c</sub> Clamping Voltage Peak voltage measured across the TVS at a specified Ippm (peak impulse current)
- ${f I}_{_{R}}$  Reverse Leakage Current -- Current measured at  ${f V}_{_{R}}$
- Forward Voltage Drop for Uni-directional

note: V<sub>F</sub> distribution range from 10V to 15V

#### Ratings and Characteristic Curves (T<sub>A</sub>=25°C unless otherwise noted)

Figure 1 - TVS Transients Clamping Waveform

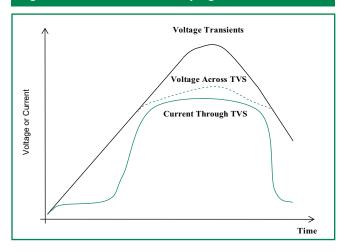
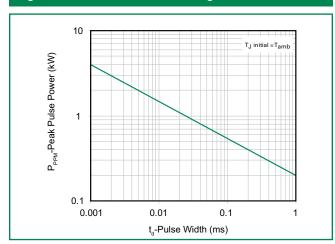


Figure 2 - Peak Pulse Power Rating Curve



**Figure 3 - Peak Pulse Power Derating Curve** 

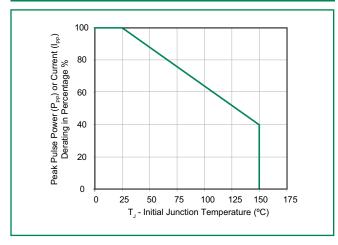
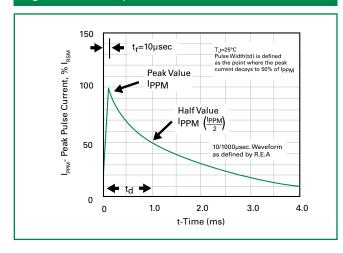


Figure 4 - 10/1000µS Pulse Waveform



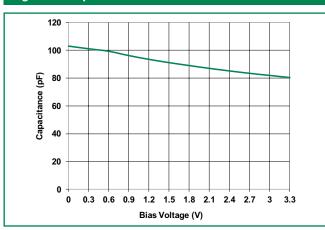
©2016 Littelfuse, Inc.

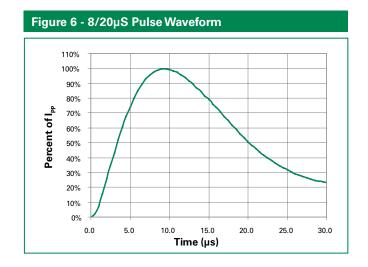
Specifications are subject to change without notice.

Revised: 07/28/16



Figure 5 - Capacitance vs. Reverse Bias



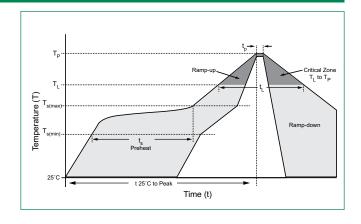


## **Soldering Parameters**

Reflow Co	ndition	Lead-free assembly	
	-Temperature Min (T <sub>s(min)</sub> )	150°C	
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C	
	-Time (min to max) (t <sub>s</sub> )	60 – 180 secs	
Average ra to peak	mp up rate (Liquidus Temp (T <sub>A</sub> )	3°C/second max	
$T_{S(max)}$ to $T_A$	- Ramp-up Rate	3°C/second max	
Reflow	-Temperature (T <sub>A</sub> ) (Liquidus)	217°C	
nellow	-Time (min to max) (t <sub>s</sub> )	60 – 150 seconds	
Peak Temp	erature (T <sub>P</sub> )	260 <sup>+0/-5</sup> °C	
Time withi Temperatu	n 5°C of actual peak re (t <sub>p</sub> )	20 – 40 seconds	
Ramp-dow	n Rate	6°C/second max	
Time 25°C	to peak Temperature (T <sub>P</sub> )	8 minutes Max.	
Do not exc	eed	260°C	



Case	SOD-123FL plastic over passivated junction		
Polarity	Color band denotes cathode except bipola		
Terminal	Matte tin-plated leads, solderable per JESD22-B102		

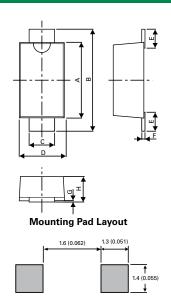


## **High Reliability Test Specification**

Pre-condition (HTRB/TC/ PCT/ H3TRB)	(1) Bake 24hrs @150°C (2)168hrs @85% RH and 85°C (3) I <sub>R</sub> reflow,3 reflows, peak temperature of 260°C
HTRB	JESD 22-108C $V_{\rm CC}$ bias= 80% $V_{\rm DRM}$ & $T_{\rm A}$ =150°C, 1008hrs
Temperature Cycling	MIL-STD-883F, Method 1010.8 Condition C -65°C to150°C, 1000 cycles
Pressure Cooker	JEDEC 22-A102C 100%RH @121°C @15psi, 96hrs
Bias Humidity (H3TRB)	JESD 22-A101B Vcc bias (pin1to pin3)=V <sub>DRM</sub> ,85%RH, 85°C , 1008 hours
RSH	JESD 22-A111 260°C ,10 secs.

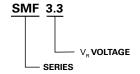


## Dimensions - SOD-123FL Package

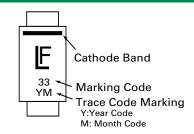


Dimensions	Millim	neters	Inches		
Dimensions	Min	Max	Min	Max	
А	2.90	3.10	0.114	0.122	
В	3.50	3.90	0.138	0.154	
С	0.85	1.05	0.033	0.041	
D	1.70	2.00	0.067	0.079	
Е	0.43	0.83	0.017	0.033	
F	0.10	0.25	0.004	0.010	
G	0.00	0.10	0.000	0.004	
Н	0.90	1.08	0.035	0.043	

#### **Part Numbering System**



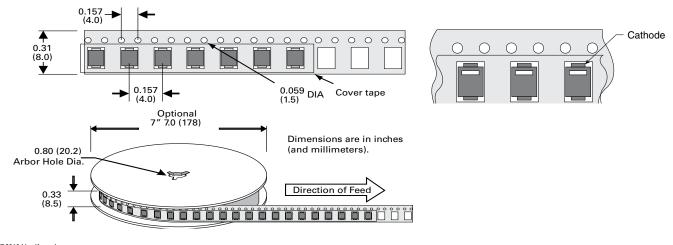
## **Part Marking System**



## **Packaging Options**

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
SMF3.3	SOD-123FL	3000	Tape & Reel – 8mm tape/7" reel	EIA RS-481

#### **Tape and Reel Specification**



©2016 Littelfuse, Inc.

Specifications are subject to change without notice.